



Material Content Data Sheet



Halogen-Free

Sales Product Name	SKB02N120	Issued	24. February 2022
MA#	MA005699766		
Package	PG-TO263-3-2	Weight*	1559.08 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip_1	inorganic material	silicon	7440-21-3	2.530	0.16	0.16	1623	1623
chip_2	inorganic material	silicon	7440-21-3	1.041	0.07	0.07	668	668
leadframe	inorganic material	phosphorus	7723-14-0	0.091	0.01		59	
	non noble metal	iron	7439-89-6	0.304	0.02		195	
	non noble metal	copper	7440-50-8	304.026	19.50	19.53	195003	195257
wire	non noble metal	aluminium	7429-90-5	1.728	0.11	0.11	1108	1108
encapsulation	inorganic material	zinc oxide	1314-13-2	6.876	0.44		4410	
	miscellaneous	miscellaneous	-	27.503	1.76		17641	
	plastics	epoxy resin	-	103.137	6.62		66153	
	inorganic material	silicon dioxide	60676-86-0	550.065	35.27	44.09	352814	441018
lead finish	non noble metal	tin	7440-31-5	9.657	0.62	0.62	6194	6194
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.228	0.01	0.01	147	148
solder	non noble metal	tin	7440-31-5	0.070			45	
	noble metal	silver	7440-22-4	0.088	0.01		56	
	non noble metal	lead	7439-92-1	3.352	0.22	0.23	2150	2251
heatspreader	inorganic material	phosphorus	7723-14-0	0.165	0.01		106	
	non noble metal	iron	7439-89-6	0.548	0.04		352	
	non noble metal	copper	7440-50-8	547.666	35.13	35.18	351275	351733
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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